Small Signal MOSFET

20 V, 220 mA / -200 mA, Complementary, 1.0 x 1.0 mm SOT-963 Package

Features

- Complementary MOSFET Device
- Offers a Low $R_{DS(on)}$ Solution in the Ultra Small 1.0x1.0 mm Package
- 1.5 V Gate Voltage Rating
- Ultra Thin Profile (< 0.5 mm) Allows It to Fit Easily into Extremely Thin Environments such as Portable Electronics.
- This is a Pb-Free Device

Applications

- · Load Switch with Level Shift
- Optimized for Power Management in Ultra Portable Equipment

MAXIMUM RATINGS (T_J = 25°C unless otherwise specified)

Para	Symbol	Value	Unit				
Drain-to-Source Voltage	V _{DSS}	20	V				
Gate-to-Source Voltag	е		V_{GS}	±8	V		
N-Channel	Steady	$T_A = 25^{\circ}C$		220			
Continuous Drain Current (Note 1)	State	$T_A = 85^{\circ}C$		160			
, , ,	t ≤ 5 s	$T_A = 25^{\circ}C$	I _D	280	mA		
P-Channel	Steady	$T_A = 25^{\circ}C$	טי	-200			
Continuous Drain Current (Note 1)	State	$T_A = 85^{\circ}C$		-140			
	t ≤ 5 s	$T_A = 25^{\circ}C$		-250			
Power Dissipation (Note 1)	Steady State	T _A = 25°C	P _D	125	mW		
	t ≤ 5 s	-A	. 0	200			
Pulsed Drain Current					mA		
	t _p = 10 μs	I _{DM}	-600	IIIA			
Operating Junction and	T _J , T _{STG}	–55 to 150	°C				
Source Current (Body D	I _S	200	mA				
Lead Temperature for S (1/8" from case for 1	T_L	260	°C				

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- Surface-mounted on FR4 board using the minimum recommended pad size, 1 oz. Cu.
- 2. Pulse Test: pulse width $\leq\!300~\mu\text{s},$ duty cycle $\leq\!2\%$

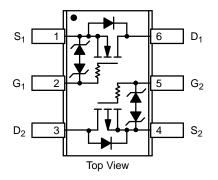


ON Semiconductor®

www.onsemi.com

V _{(BR)DSS}	R _{DS(on)} Max	I _D Max
	1.5 Ω @ 4.5 V	
N-Channel	2.0 Ω @ 2.5 V	
20 V	3.0 Ω @ 1.8 V	0.22 A
	4.5 Ω @ 1.5 V	
	5.0 Ω @ -4.5 V	
P-Channel 20 V	6.0 Ω @ -2.5 V	-0.2 A
	7.0 Ω @ –1.8 V	-0.2 A
	10 Ω @ -1.5 V	

PINOUT: SOT-963





SOT-963 CASE 527AD MARKING DIAGRAM



2 = Specific Device Code M = Date Code

ORDERING INFORMATION

Device	Package	Shipping [†]
NTUD3169CZT5G	SOT-963 (Pb-Free)	8000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Max	Unit
Junction-to-Ambient - Steady State, Minimum Pad (Note 3)	$R_{ heta JA}$	1000	°C/W
Junction-to-Ambient - t ≤ 5 s (Note 3)		600	

^{3.} Surface-mounted on FR4 board using the minimum recommended pad size, 1 oz. Cu.

ELECTRICAL CHARACTERISTICS (T_{.1} = 25°C unless otherwise specified)

Parameter	Symbol	N/P	Test Condition		Min	Тур	Max	Unit	
OFF CHARACTERISTICS		•							
Drain-to-Source Breakdown Voltage		N	V _{GS} = 0 V	I _D = 250 μA	20				
	$V_{(BR)DSS}$	Р		I _D = -250 μA	-20			V	
Zero Gate Voltage Drain Current		N	V _{GS} = 0 V, V _{DS} = 5.0 V	T _J = 25°C			50		
				T _J = 85°C			200		
	I _{DSS}			T _J = 25°C			-50	nA	
		Р	$V_{GS} = 0 \text{ V}, V_{DS} = -5.0 \text{ V}$	T _J = 85°C			-200		
Zero Gate Voltage Drain Current		N	V _{GS} = 0 V, V _{DS} = 16 V				100		
	I _{DSS}	Р	$V_{GS} = 0 \text{ V}, V_{DS} = -16 \text{ V}$	$T_J = 25^{\circ}C$			-100	nA	
Gate-to-Source Leakage Current		N					±100		
	I_{GSS}	Р	$V_{DS} = 0 V, V_{GS} =$	±5.0 V			±100	nA	
ON CHARACTERISTICS (Note 4)		•			•	•			
Gate Threshold Voltage		N	$V_{GS} = V_{DS}$	$I_D = 250 \mu A$ 0.4 $I_D = -250 \mu A$ -0.4	0.4		1.0	V	
	$V_{GS(TH)}$	Р				-1.0			
Drain-to-Source On Resistance	R _{DS(on)}	N	$V_{GS} = 4.5 \text{ V}, I_{D} =$	100 mA		0.75	1.5	1	
		Р	$V_{GS} = -4.5V$, $I_D = -100$ mA			2.0	5.0	Ω	
		N	$V_{GS} = 2.5 \text{ V}, I_D = 50 \text{ mA}$			1.0	2.0		
		Р	$V_{GS} = -2.5V$, $I_D = -50$ mA			2.6	6.0		
		N	$V_{GS} = 1.8 \text{ V}, I_D = 20 \text{ mA}$			1.4	3.0		
		Р	$V_{GS} = -1.8V, I_D = -20 \text{ mA}$			3.4	7.0		
		N	$V_{GS} = 1.5 \text{ V}, I_D = 10 \text{ mA}$			1.8	4.5		
		Р	$V_{GS} = -1.5 \text{ V}, I_D = -10 \text{ mA}$			4.0	10		
		N	V _{GS} = 1.2 V, I _D = 1.0 mA			2.8			
		Р	$V_{GS} = -1.2 \text{ V}, I_D = -1.0 \text{ mA}$			6.0			
Forward Transconductance		N	$V_{DS} = 5.0 \text{ V}, I_D = 125 \text{ mA}$			0.48		•	
	9FS	Р	$V_{DS} = -5.0 \text{ V}, I_{D} = -125 \text{ mA}$			0.35		S	
Source-Drain Diode Voltage	V_{SD}	N	$V_{GS} = 0 \text{ V}, I_{S} = 10 \text{ mA}$	$T_J = 25^{\circ}C$		0.6	1.0	V	
		Р	V _{GS} = 0 V, I _S = -10 mA			-0.6	-1.0		
CAPACITANCES									
Input Capacitance	C _{ISS}		N $f = 1 \text{ MHz}, V_{GS} = 0 \text{ V}$ $V_{DS} = 15 \text{ V}$			12.5			
Output Capacitance	C _{OSS}	N				3.6			
Reverse Transfer Capacitance	C _{RSS}					2.6			
Input Capacitance	C _{ISS}		f = 1 MHz, V _{GS} = 0 V V _{DS} = -15 V			13.5		pF	
Output Capacitance	C _{OSS}	Р				3.8			
Reverse Transfer Capacitance	C _{RSS}	1				2.0			

^{4.} Switching characteristics are independent of operating junction temperatures

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	N/P	Test Condition	Min	Тур	Max	Unit
SWITCHING CHARACTERISTICS, V _{GS} = 4.5 V (Note 4)							
Turn-On Delay Time	t _{d(ON)}	- N	V_{GS} = 4.5 V, V_{DD} = 10 V, I_{D} = 200 mA, R_{G} = 2.0 Ω		16.5		
Rise Time	t _r				25.5		
Turn-Off Delay Time	t _{d(OFF)}				142		
Fall Time	t _f				80		
Turn-On Delay Time	t _{d(ON)}	Р	$V_{GS} = -4.5 \text{ V}, V_{DD} = -15 \text{ V},$ $I_{D} = -200 \text{ mA}, R_{G} = 2.0 \Omega$		26		ns
Rise Time	t _r				46]
Turn-Off Delay Time	t _{d(OFF)}	7 -			196		
Fall Time	t _f	1			145		

^{4.} Switching characteristics are independent of operating junction temperatures

TYPICAL CHARACTERISTICS (N-CHANNEL)

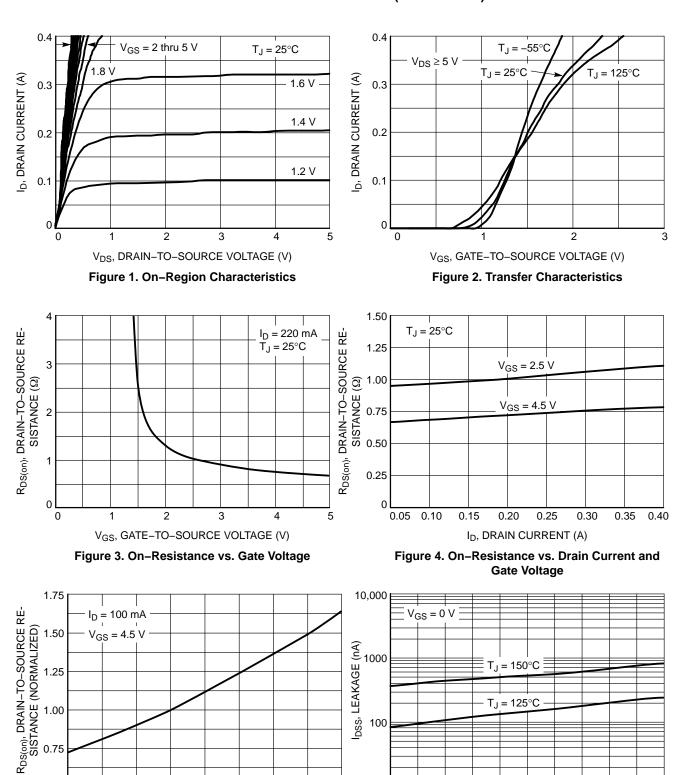


Figure 5. On–Resistance Variation with Temperature

50

T_J, JUNCTION TEMPERATURE (°C)

100

125

0.50

-50

-25

Figure 6. Drain-to-Source Leakage Current vs. Voltage

V_{DS}, DRAIN-TO-SOURCE VOLTAGE (V)

20

150

10

0

TYPICAL CHARACTERISTICS (N-CHANNEL)

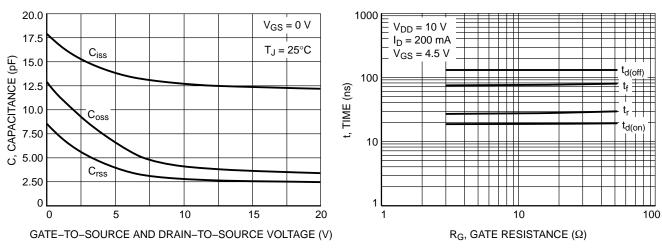


Figure 7. Capacitance Variation

Figure 8. Resistive Switching Time Variation vs. Gate Resistance

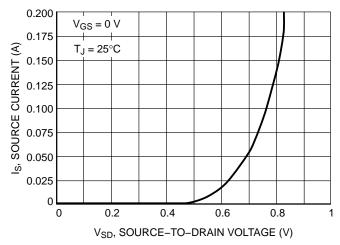


Figure 9. Diode Forward Voltage vs. Current

TYPICAL CHARACTERISTICS (P-CHANNEL)

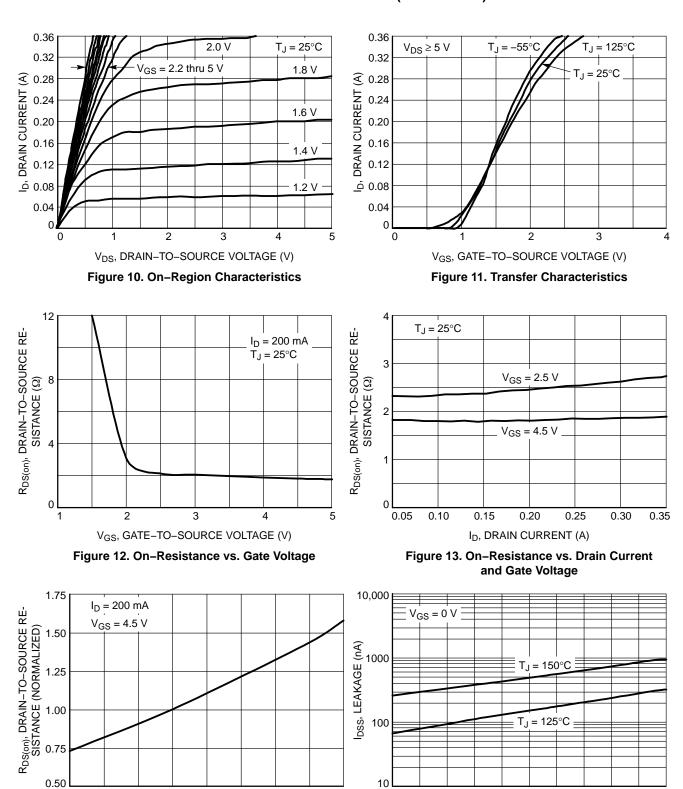


Figure 14. On–Resistance Variation with Temperature

50

T_J, JUNCTION TEMPERATURE (°C)

100

125

-50

-25

Figure 15. Drain-to-Source Leakage Current vs. Voltage

V_{DS}, DRAIN-TO-SOURCE VOLTAGE (V)

20

150

TYPICAL CHARACTERISTICS (P-CHANNEL)

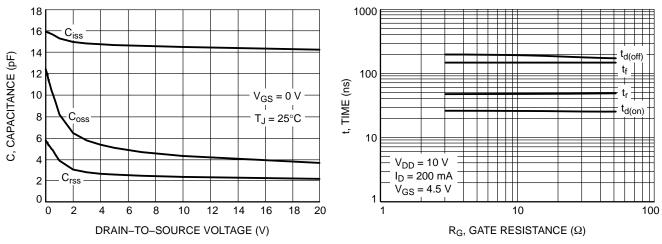


Figure 16. Capacitance Variation

Figure 17. Resistive Switching Time Variation vs. Gate Resistance

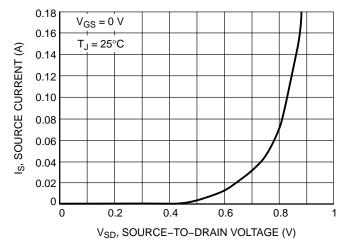
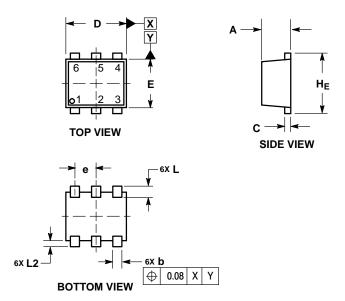


Figure 18. Diode Forward Voltage vs. Current

PACKAGE DIMENSIONS

SOT-963 CASE 527AD ISSUE E

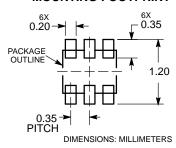


NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME
- Y14.5M, 1994.
 CONTROLLING DIMENSION: MILLIMETERS
 MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF
- BASE MATERIAL.
 DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

	MILLIMETERS				
DIM	MIN	NOM	MAX		
Α	0.34	0.37	0.40		
b	0.10	0.15	0.20		
С	0.07	0.12	0.17		
D	0.95	1.00	1.05		
E	0.75	0.80	0.85		
е	0.35 BSC				
HE	0.95	1.00	1.05		
L	0.19 REF				
L2	0.05	0.10	0.15		

RECOMMENDED MOUNTING FOOTPRINT



ON Semiconductor and III) are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free

Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center

Phone: 81–3–5817–1050

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative